

## T493D106K025CC6411

T493 HRA, Tantalum, MnO<sub>2</sub> Tantalum, HRA, 10 uF, 10%, 25 VDC, SMD, MnO<sub>2</sub>, Molded, High Reliability, C (0.01%/1000 Hrs), 1 Ohms, 7343, Height Max = 3.1mm

CATHODE (-) END VIEW



SIDE VIEW



ANODE (+) END VIEW



BOTTOM VIEW



Click [here](#) for the 3D model.

### General Information

Series	T493 HRA
Dielectric	MnO <sub>2</sub> Tantalum
Style	SMD Chip
Description	SMD, MnO <sub>2</sub> , Molded, High Reliability
Features	High Reliability
RoHS	No
Prop 65	<b>⚠ WARNING:</b> Cancer and reproductive harm - <a href="http://www.p65warnings.ca.gov">http://www.p65warnings.ca.gov</a> .
SCIP Number	573c56ea-c4cc-4850-b749-53802fe9068f
Termination	Hot Solder Dipped
AEC-Q200	No
Component Weight	412.33 mg
Miscellaneous	F1 Technology + Simulated Breakdown Screening (SBDS).
Notes	P and R dimensions represents the minimum solderable area of the termination surface entirely below cutout (if one is present).

### Dimensions

Footprint	7343
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
H	2.8mm +/-0.3mm
T	0.13mm REF
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
A	3.8mm MIN
B	0.5mm +/-0.15mm
E	3.5mm REF
G	3.5mm REF
P	0.5mm MIN
R	1mm REF
X	0.1mm +/-0.1mm

### Specifications

Capacitance	10 uF
Capacitance Tolerance	10%
Voltage DC	25 VDC (85C), 16.75 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	6% 120Hz 25C
Failure Rate	C (0.01%/1000 Hrs)
Resistance	1 Ohms (100kHz 25C)
Leakage Current	2.5 uA (5min 25°C)
Testing and Reliability	10 Cycles Surge Current Testing At -55C And +85C Before Weibull

### Packaging Specifications

Packaging	T&R, 178mm
Packaging Quantity	500

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